

2.0x1.25mm SMD CHIP LED LAMP

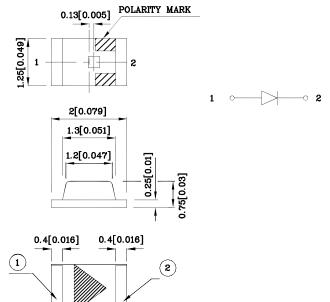
#### **Features**

- Ideal for indication light on hand held products
- Long life and robust package
- Standard Package: 2,000pcs/ Reel
- $\bullet$  MSL (Moisture Sensitivity Level): 3
- RoHS compliant





## Package Schematics



#### Notes

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.1(0.004")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T <sub>A</sub> =25°C)		MG (GaP)	Unit	
Reverse Voltage	$V_{\mathrm{R}}$	5	V	
Forward Current	$I_{\mathrm{F}}$	25	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	140	mA	
Power Dissipation	$P_{D}$	62.5	mW	
Operating Temperature	$T_{\mathrm{A}}$	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85	C	

Operating Characteristics (T <sub>A</sub> =25°C)	MG (GaP)	Unit	
Forward Voltage (Typ.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	2.2	V
Forward Voltage (Max.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	2.5	V
Reverse Current (Max.) $(V_R=5V)$	$I_R$	10	uA
Wavelength of Peak Emission CIE127-2007*(Typ.) (I <sub>F</sub> =20mA)	λΡ	565*	nm
Wavelength of Dominant EmissionCIE127-2007* (Typ.) (I <sub>F</sub> =20mA)	λD	568*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	$\triangle \lambda$	30	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	15	pF

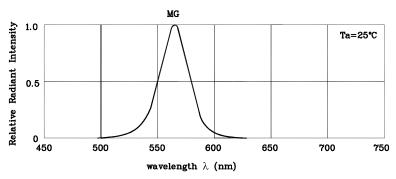
Part Number	Emitting Color	Emitting Material	Lens-color	$\begin{array}{c} \text{Luminous Intensity} \\ \text{CIE127-2007*} \\ \text{(I_F=20mA)} \\ \text{mcd} \end{array}$		Wavelength CIE127-2007* nm λP	Viewing Angle 2θ 1/2
				min.	typ.		
XZMG54W-1	Green	GaP	Water Clear	5*	11*	565*	120°

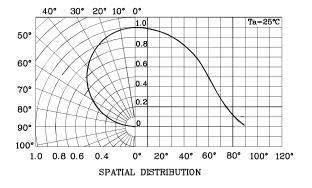
<sup>\*</sup>Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

Mar 25,2014



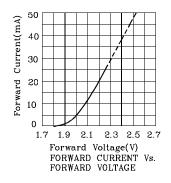


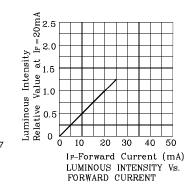


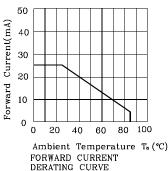


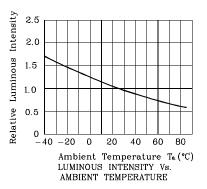
RELATIVE INTENSITY Vs. CIE WAVELENGTH

#### **❖** MG



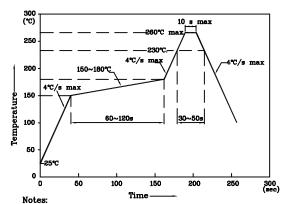






# LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)

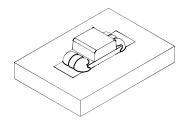


- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions

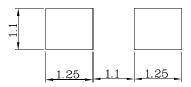




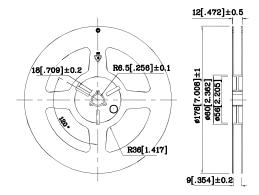
❖ The device has a single mounting surface. The device must be mounted according to the specifications.



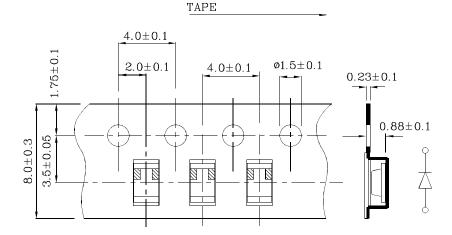
**❖** Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



#### \* Reel Dimension



#### **❖** Tape Specification (Units:mm)



### Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

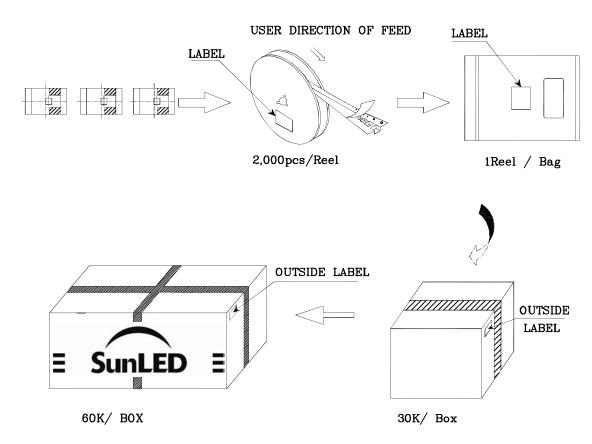
- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

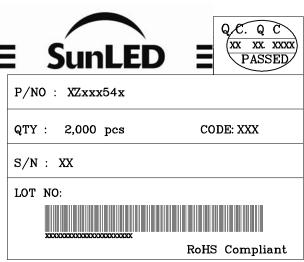
Note: Accuracy may depend on the sorting parameters.





#### PACKING & LABEL SPECIFICATIONS





#### TERMS OF USE

- $1.\ Data\ presented\ in\ this\ document\ reflect\ statistical\ figures\ and\ should\ be\ treated\ as\ technical\ reference\ only.$
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
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